

SMAF Plastic-Encapsulate Diodes

Schottky Rectifier

Features

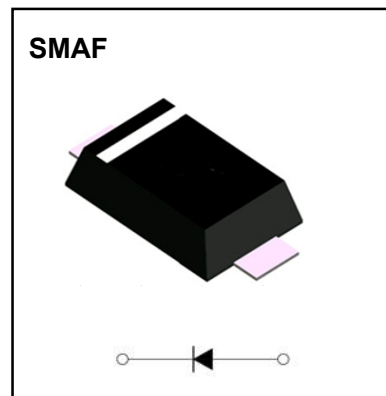
- I_o 3A
- V_{RRM} 40V
- High surge current capability
- Low V_f

Applications

- Rectifier

Marking

- SSL34



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	SSL34F
Repetitive Peak Reverse Voltage	V_{RRM}	V		40
Maximum RMS Voltage	V_{RMS}	V		28
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_L=100^{\circ}C$	3.0
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave,1 cycle, $T_a=25^{\circ}C$	150
Junction Temperature	T_J	$^{\circ}C$		-55~+125
Storage Temperature	T_{STG}	$^{\circ}C$		-55~+150

Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		SSL34F	
Peak Forward Voltage	V_F	V	$I_F=1A$ $I_F=2A$ $I_F=3A$	$T_a=25^{\circ}C$	0.37(TYP) 0.40(MAX) 0.40(TYP) 0.42(MAX) 0.43(TYP) 0.45(MAX)	
Peak Reverse Current	I_{RRM1}	mA	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}C$	0.04(TYP) 0.1(MAX)	
	I_{RRM2}			$T_a=100^{\circ}C$	10	
Thermal Resistance(Typical)	$R_{\theta J-A}$	$^{\circ}C/W$	Between junction and ambient		60	
	$R_{\theta J-L}$		Between junction and lead		20	

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

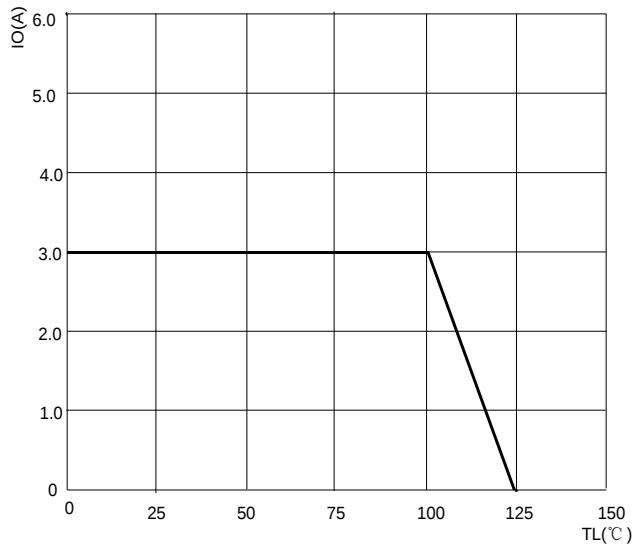


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

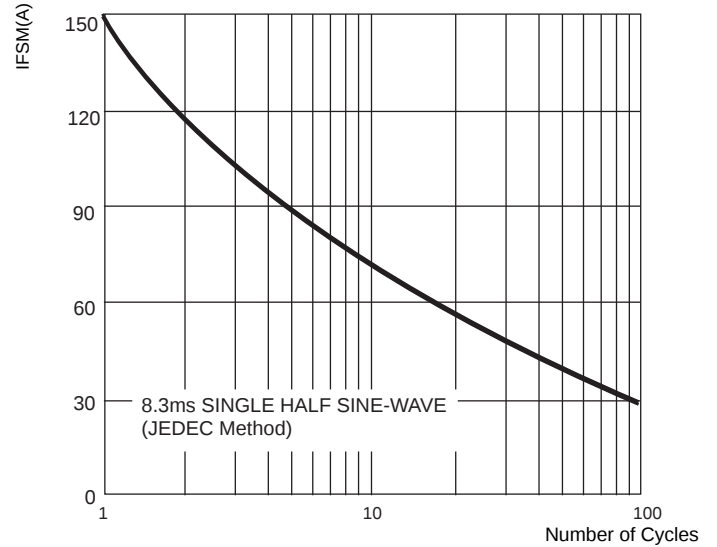


FIG3: Forward Voltage

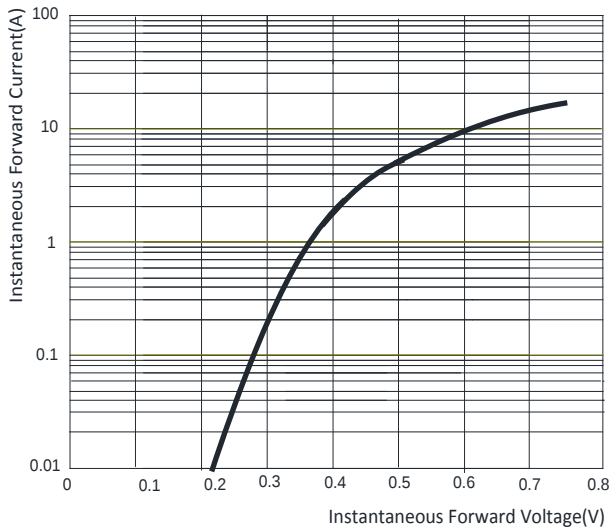
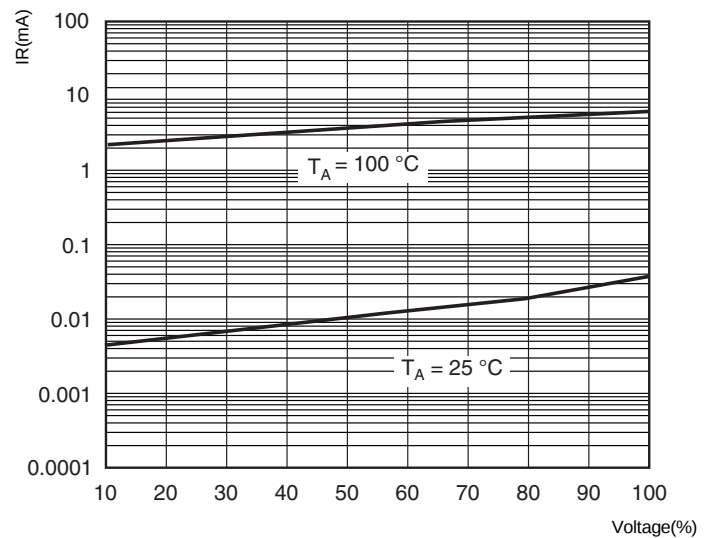
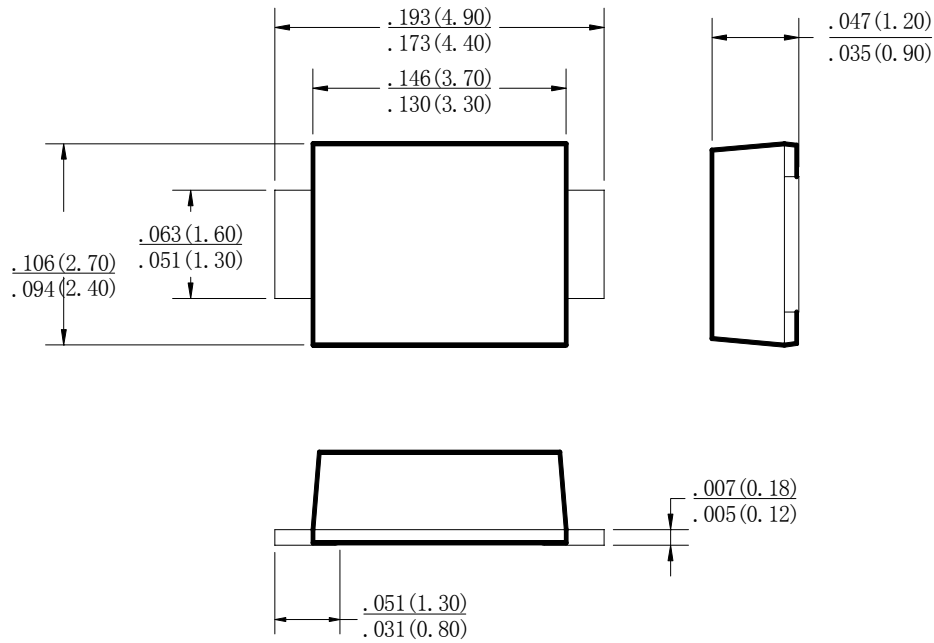


FIG.4: TYPICAL REVERSE CHARACTERISTICS

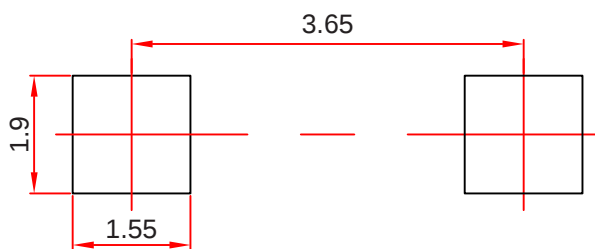


SMAF Package Outline Dimensions



Dimensions in inches and (millimeters)

SMAF Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSHD does not assume any liability arising out of the application or use of any product described herein.

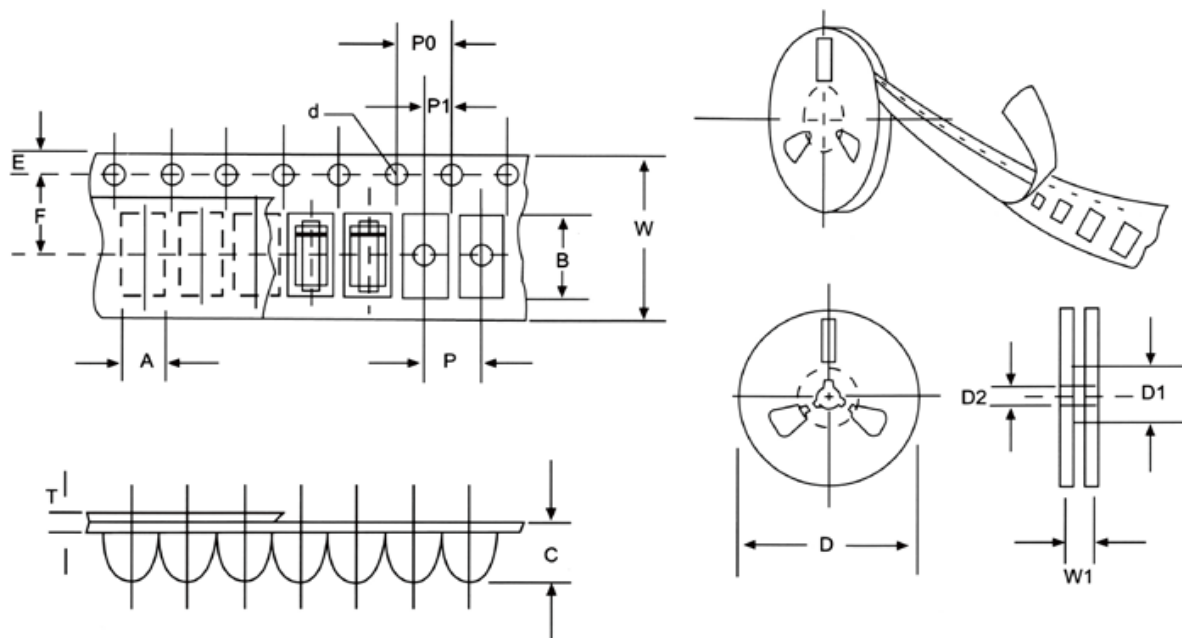


FIG:CONFIGURATION OF AXIAL TAPING

ITEM	SYMBOL	SMAF mm(inch)
Carrier width	A	2.83+0.1(0.112+0.004)
Carrier length	B	4.90+0.1(0.193+0.004)
Carrier depth	C	1.45+0.1(0.057+0.004)
Sprocket hole	d	1.55+0.05(0.061+0.002)
Reel outside diameter	D	178+2.0(7.0+0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13+0.5(0.512+0.020)
Strocket hole position	E	1.75+0.1(0.069+0.004)
Punch hole position	F	5.5+0.05(0.217+0.002)
Punch hole pitch	P	4.0+0.1(0.157+0.004)
Sprocket hole pitch	P0	4.0+0.1(0.157+0.004)
Embossment center	P1	2.0+0.1(0.079+0.004)
Totall tape thickness	T	0.23-0.29(0.009-0.011)
Tape width	W	12.0+0.1(0.472+0.004)
Reel width	W1	16.8+2.0(0.661+0.079)

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.